February, 2002





Technical Specification for Optical Transceiver Module

SCM6428

SI In Si	55.52Mbps nort Haul termediate Reach ngle 5.0 V 3 µm ransmitter	622.08Mbps Long Haul Long Reach Single 3.3 V 1.55 µm Receiver 2R / 3R)	other other	2488.32Mbps Intra office Short Reach ceiver(2 X 5) 3R)
	sc SI	:M6428-GL-ZN, SCM6428- M6428-GL-ZW, SCM6428- JMITOMO ELECT t to make changes in this s	-gl-cw, scm6 FRIC	428-GL-DW
	operties for appropriate use of re reading this specification. Wrong operation without foll		efinitions are as sho	
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(SCM6428)	indicates compulso	ery actions or instructions. Action	details are explain	еи шегеаπег.

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1. General

Features and applications of SCM6428 are listed below.

Features

* Multi Bit Rate Operation 155Mbps ~ 2.5Gbps

* Power Supply Voltage Single +3.3V

* Compact Package Size 49.0 X 13.59 X 9.8 mm (max.)

* Electrical Interface AC for DATA and LVTTL for Signal Detect and Laser Disable

* Fiber Coupled Power -3 ~ -10dBm into SMF

* Input Power Range -3 ~ -18dBm

* Laser Disable Function

* Signal Detect (SD) Function

* Connector Interface LC Duplex Connector

Applications

*Telecommunications

*Data communications

>High Speed Rack-to-Rack Data Links

- > SONET/SR, SDH/IO Application
- > ATM Application
- > Shelf-to-Shelf Multi Bit Rate Application
- > Subscriber Loop
- > Metropolitan Area Network

2. Block Diagram

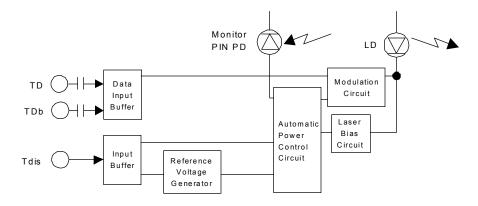


Figure 1. Block Diagram (Transmitter)

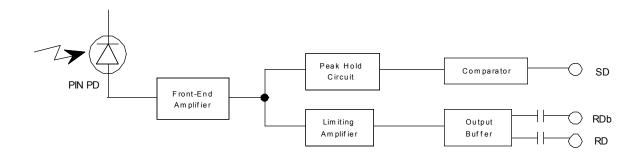


Figure 2. Block Diagram (Receiver)

∧ Caution

Do not disassemble this product. Otherwise, failure, electrical shock, overheating or fire may occur.

y Handle the lead pins carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body.

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3. Package Dimension

3.1 SCM6428-GL-Z#

All dimensions are in mm.

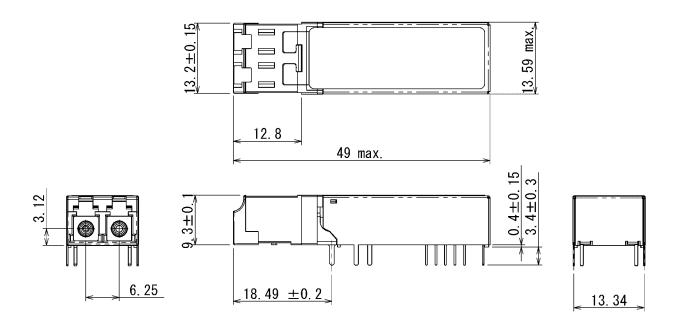


Figure 3. Outline Dimensions (SCM6428-GL-ZN)

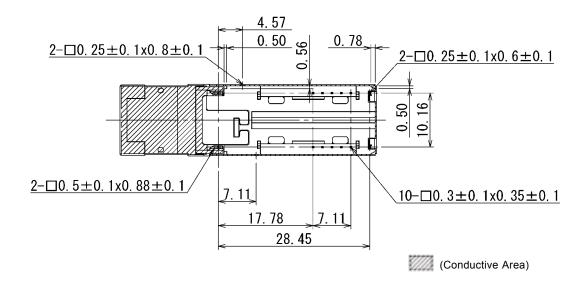
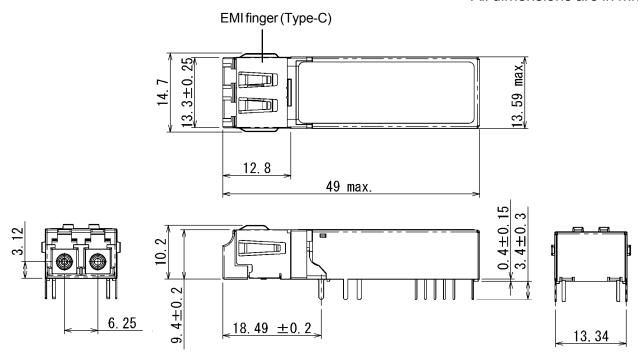


Figure 4. Bottom Side (SCM6428-GL-ZN)

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3.2 SCM6428-GL-C#

All dimensions are in mm.



Type-C EMI finger is an option for transceivers to be used on the card-edge with the receptacle protruding through a panel opening. It has fingers on three sides to make electrical contact with the sides of the bezel opening for grounding purpose.

Figure 5. Outline Dimensions (SCM6428-GL-CN)

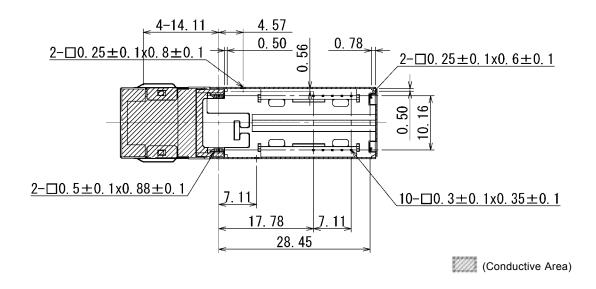
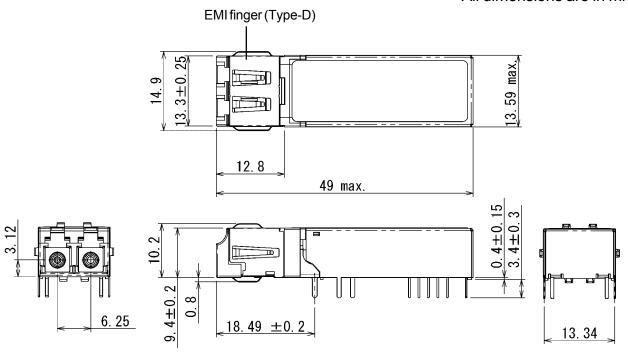


Figure 6. Bottom Side (SCM6428-GL-CN)

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3.3 SCM6428-GL-D#

All dimensions are in mm.



Type-D EMI finger is an option for transceivers to be used on the card-edge with the receptacle protruding through a panel opening. It has fingers on four sides to make electrical contact with the sides of the bezel opening for grounding purpose.

Figure 7. Outline Dimensions (SCM6428-GL-DN)

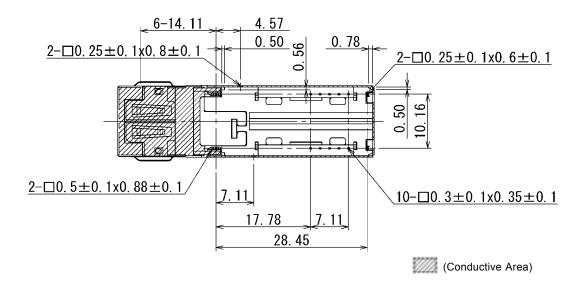


Figure 8. Bottom Side (SCM6428-GL-DN)

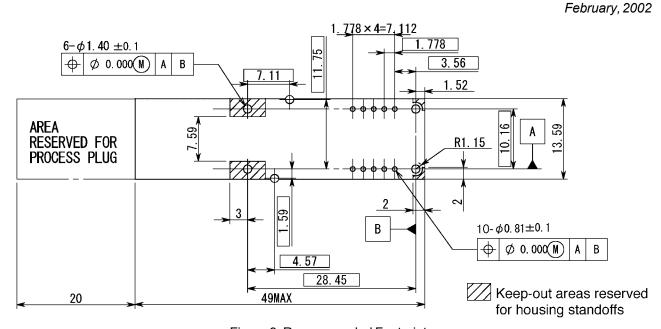


Figure 9. Recommended Footprint

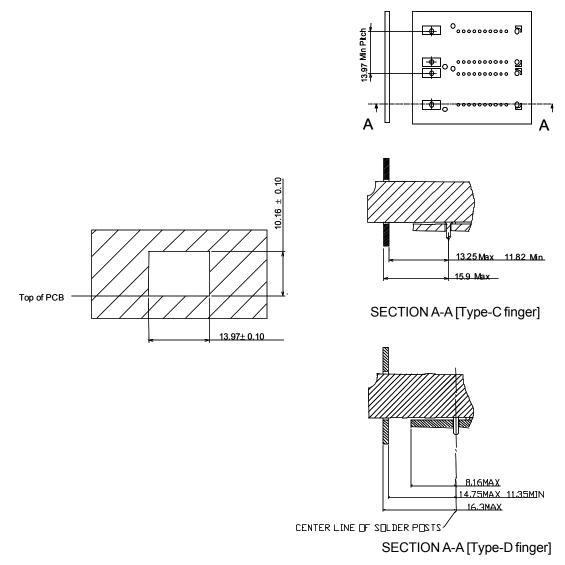


Figure 10. Recommended Bezel Design for Systems Using SFF Transceivers

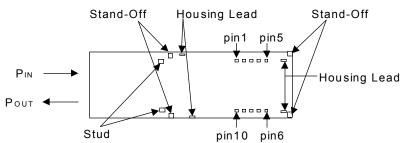
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4. Pin Assignment

No.	Symbol	I/O/P	Level	Description
1	VeeR	Р	GND	Power Supply (-) for Receiver.
2	VccR	Р	+3.3V DC	Power Supply (+) for Receiver.
3	SD	0	LVTTL	Signal Detect. High level indicates presence of optical input signal (Active High).
4	RDb	0	AC	Inverted Receiver Output Data. AC coupled.
5	RD	0	AC	Non-Inverted Receiver Output Data. AC coupled.
6	VccT	Р	+3.3V DC	Power Supply (+) for Transmitter.
7	VeeT	Р	GND	Power Supply (-) for Transmitter.
8	Tdis	- 1	LVTTL/LVCMOS	Transmitter Disable (Active High). Defaults to logic 0 (enable TX) when left open.
9	TD	I	AC	Non-Inverted Transmitter Input Data. AC coupled.
10	TDb	I	AC	Inverted Transmitter Input Data. AC coupled.

Notes

^{1.} I/O/P stands for signal input, signal output, and DC power/bias supply, respectively.



- * Mounting Studs are provided for mechanical support to the circuit board.
 It is recommended that the holes in the circuit board be connected to frame ground.
- * Stand-Offs provide gap between the circuit board and the module to help escape residual water after aqueous wash.

Figure 11. Bottom View

5. Absolute Maximum Ratings

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Storage Case Temperature		Ts	-40	-	85	°C	1
Operating Case Temperature		Tc	-5	-	70	°C	2, 6
			-40		85		3, 6
Supply Voltage		Vcc	0.0	-	4.0	V	
Input Voltage		Vi	0	-	Vcc+0.5	V	4
Lead Soldering	Temperature	Ltemp			260	°C	5
	Time	Ltime			10	sec.	

Notes

^{5.} Measured on lead pin at 2mm (0.079in.) off the package bottom 6. Refer to Section 9-2 for Tc definition.



Ω

Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

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^{1.} No condensation allowed. 2. SCM6428-GL-#N 3. SCM6428-GL-#W; 1m/s air flow recommended 4. Tdis

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6. Electrical Interface

(Unless otherwise specified, Vcc = 3.135 to 3.465 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc	3.135	3.30	3.465	V	
Supply Current		Idtx		95	200	mA	1, 2
Differential Input Voltage Swing (TD,TDb)		Vin	0.4		2.00	Vp-p	3
Signal Input Rise/Fall Time		tr / tf			120	psec	4
Tdis Input Voltage	High	Vdi	2.0		Vcc	V	F
	Low	Vei	0.0		0.8	V	5
Turn-on Time		ton			1	ms	6
Turn-off Time		toff			10	μs	6

Notes

- 1. 50% duty cycle data.
- 2. 2488.32Mbps
- 3. Refer to Figure 13.
- 4. 20 ~ 80%
- LVTTL input. Refer to Section 8, "Relation between Disable Input Voltage and Optical Output Power", for detail.
- 6. Refer to Figure 12.

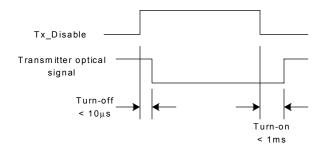


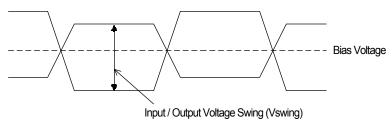
Figure 12. Definition of Turn-on / Turn-off Time

6-2. Receiver side

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc	3.135	3.30	3.465	V	
Supply Current		Idrx		95	150	mA	
Differential Output Voltage Swing (RD,RDb)		Vout	0.80		1.90	Vp-p	
SD	High	Vsoh	2.40		Vcc	V	
Output Voltage	Low	Vsol	0.0		0.5		
Data Rise / Fall Time		tr / tf		140 / 120		psec	1
SD Assert Time		ta	2.3		100	μsec	2
SD Deassert Time		td	2.3		350	μsec	

Notes

- 1. 20~80%
- 2. 2488.32Mbps, PRBS 2^23-1, NRZ



Differential Input / Output Voltage Swing (Vin / Vout) = 2 X Vswing

Figure 13. Definition of Differential Input / Output Voltage Swing

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7. Optical Interface

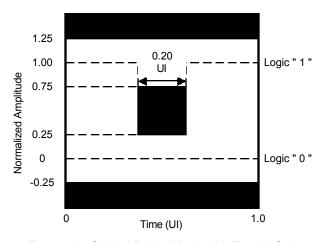
(Unless otherwise specified, Vcc = 3.135 to 3.465 V and all operating temperature shall apply.)

7-1. Transmitter side

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Average Output Power	Po	-10.0		-3.0	dBm	1
Extinction Ratio	Er	8.2			dB	1
Center Wavelength	λς	1266		1360	nm	
Spectral Width (RMS)	Δλ			4	nm	
Eye Mask for Optical Output	Comp	liant with Bello	ore GR-253 C	ORE and ITU	G957	
Jitter Generation	Tjpk			0.1	Ulp-p	2
	Tjrms			0.01	Ulrms	_

Note 1. Measured at 2488.32Mbps PRBS2^23-1, 50% duty cycle, NRZ, Tdis = L (Tdis = H : Max -45dBm)

Measured with a bandpass filter having a high-pass cutoff freguency of 12kHZ and a low-pass cutoff freguency of 20MHZ.



Relation between Input Signal and Optical Output Signal

and Option Output Oignal					
Input	Signal	Optical Output Signal			
TD TDb					
High	Low	ON (High)			
Low	High	OFF (Low)			
High	High	Undefined			
Low	Low	Undefined			

Figure 14. Optical Pulse Mask with Fourth Order

Bessel-Thomson Filter Specified in ITU-T G.957

Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

7-2. Receiver side

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Center Wavelength	-	1260		1580	nm	
Minimum Sensitivity	Pmin		-24.0	-18.0	dBm	1, 2
Overload	Pmax	-3.0			dBm	1, 2
SD Assert Level	Pa		-27.0	-18.0	dBm	2
SD Deassert Level	Pd	-40.0	-29.5		dBm	
SD Hysteresis	Phys	0.5	2.5		dB	
Reflectance	REFr		-14		dB	

Notes 1. BER=10^-10

8. Relation between Disable Input Voltage and Optical Output Power

Disable Input Voltage	Optical Output Power
"L"(0 ~ 0.8V)	Enabled
"H"(2.0V ~ Vcc)	Disabled (<-45dBm)

^{*}Note: Enabled for no Disable input (Pin 8 open)

^{2.} SONET OC-48c data pattern filled with a 2^23 -1 PRBS payload.

^{2.} Measured at 2488.32Mbps, PRBS 2^23-1, NRZ

9. Recommended Information

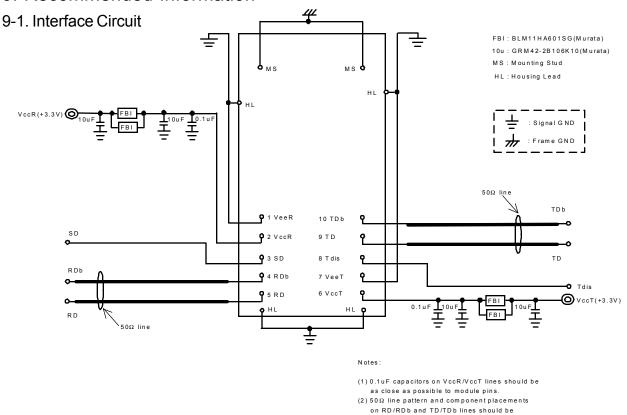


Figure 15. Recommended Interface Circuit

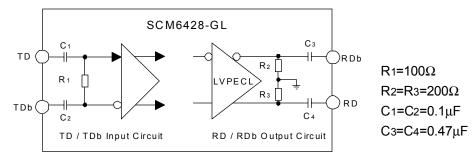
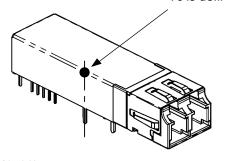


Figure 16. Data Input / Output Circuit

9-2. Tc Definition

Tc is defined as surface temperature of this point.



Forced convection (minimum 1.0m/s) is recommended to ensure Tc be kept below its absolute maximum rating where the ambient temperature is close to the maximum allowed Tc.

 $\verb"symmetrical" for better impedance matching"$

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10. Reliability Test Program

GR-468-CORE Issue 1, December 1998 Laser Module

HEADING	TEST	REFERENCE	CONDITIONS	SAM	1PLIN	G
				LTPD	SS	С
	Mechanical	MIL-STD-883	5 times/axis			
	Shock	Method 2002	1,500G, 0.5ms	20	11	0
Mechanical	Vibration	MIL-STD-883	Cond. A 20G, 20-2,000	20	11	0
Integrity		Method 2007	Hz, 4min/cy, 4cy/axis			
	Thermal Shock	MIL-STD-883	Delta T=100°C	20	11	0
		Method 1011	0°C to 100°C			
	Solderability	MIL-STD-883	(steam aging not	20	11	0
		Method 2003	required)			
	Accel. Aging	(R)-4-53 Section	85°C; rated power			-
	(High Temp.)	5.18	1,000 hrs. for pass/fail	-	25	
			2,000, 5,000 hrs. for info.		10	
Endurance	Low Temp.	-	min. storage T	20	11	0
	Storage		1,000 hrs. for pass/fail			
			2,000 hrs. for info.			
	Temperature	Section 5.20	-40°C to +85°C			
	Cycling		500 for pass/fail	20	11	0
			1,000 for info.	-	11	-
	Damp Heat	MIL-STD-202	85°C/85%RH 1,000hrs.	20	11	0
		Method 103 or				
		IEC-60068-2-3				
	Cyc. Moist. Res.	Sec. 5.23	-	20	11	0
Special Tests	Internal	MIL-STD-883	Max. 5,000ppm water	20	11	0
	Moisture	Method 1018	vapour			
	ESD Threshold	Section 5.22		-	6	-

SS: Sample Size

C: Maximum number of failure allowed to pass the test.

11. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acceptable FDA, complies with 21CFR 1040. 10 and 1040.11. Also this product is a laser class 1 product acceptable IEC 60825-1.

Class 1 Laser Product

⚠ Caution

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If this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classification for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

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12. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

⚠ Warning



Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.

Do not put this product or components of this product into your mouth. This product contaions material harmful to health.



Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

13. Ordering Information

SCM6428 - GL - \square (LC Duplex Receptacle, Metallized)

Operating Case Temperature

N : Tc=-5~70°C W : Tc=-40~85°C

EMI Shield Finger Option

Z: Without Finger

C: With Type-C FingerD: With Type-D Finger

14. For More Information

U.S.A.

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